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PAGE 1/6 \* RCVD AT 10/7/2005 2:09:49 PM [Eastern Daylight Time] \* SVR:USPTO-EFAX-6/1 \* DNIS:8729306 \* CSID:5109233360 \* DURATION (mm-ss):01-56

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Reference to: 10/765,346  
Application No.: 1/26/2004  
Filing date: 2813  
Art unit: Hui Peng  
Applicants: New Flip Chip Assemblies and Lamps of High Power GaN LEDs, Wafer Level Flip Chip Package Process, and Method of Fabricating the Same  
Title: Jennifer M. Dolan/2313  
Examiner/Art Unit

Fremont, CA, Oct. 7, 2005

AMENDMENT A

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22315-1450

Sir/Ms.:

This letter responds to the Office Action Summary. Please amend the above patent application as the following.

TITLE: Amendment to the title of the above patent application is on page 2 of this amendment.

SPECIFICATION: There is no amendment to the specification.

CLAIMS: Amendment to the claims of the above patent application begin on page 3 of this amendment.

DRAWINGS: There is no amendment to the drawings.

REMARKS: Remarks begin on page 5 of this amendment.

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